

Vishay Siliconix

P-Channel 60-V (D-S), 175°C MOSFET

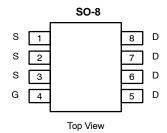
PRODUCT SUMMARY			
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)	
-60	0.120 @ V _{GS} = -10 V	±3.5	
	0.15 @ V _{GS} = -4.5 V	±3.1	

FEATURES

- TrenchFET® Power MOSFET
- 175°C Maximum Junction Temperature



Pb-free Available



Ordering Information: Si9407AEY
Si9407AEY—T1
Si9407AEY—E3 (Lead (Pb)-Free with Tape and Reel)
Si9407AEY-1—E3 (Lead (Pb)-Free) with Tape and Reel)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25° C UNLESS OTHERWISE NOTED)							
Parameter		Symbol	Limit	Unit			
Drain-Source Voltage		V _{DS}	-60	.,			
Gate-Source Voltage		V_{GS}	±20	V			
O 11	T _A = 25°C		±3.5				
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70°C	I _D	±3.0	1 .			
Pulsed Drain Current		I _{DM}	±30	A			
Continuous Source Current (Diode Conduction) ^a		I _S	-2.5	1			
Marianana Danisa Dinisa dina	T _A = 25°C		3.0	W			
Maximum Power Dissipation ^a	T _A = 70°C	P _D	2.1				
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 175	°C			

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Maximum Junction-to-Ambient ^a	R _{thJA}	50	°C/W	

Notes

a. Surface Mounted on FR4 Board, $t \le 10$ sec.

Si9407AEY

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Parameter	Symbol	Test Condition	Min	Typ ^a	Max	Unit	
Static	<u> </u>			JI.	l .		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1		-3	V	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			±100	nA	
Zana Oata Valta na Dunin Ournant	I _{DSS}	V_{DS} =60 V, V_{GS} = 0 V			-1	uΑ	
Zero Gate Voltage Drain Current		$V_{DS} =60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			-10		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-20			Α	
Drain-Source On-State Resistance ^b	r _{DS(on)}	$V_{GS} = -10 \text{ V}, I_D = 3.5 \text{ A}$			0.120		
		$V_{GS} = -4.5 \text{ V}, I_D = 3.1 \text{ A}$			0.150	Ω	
Forward Transconductance ^b	9fs	$V_{DS} = -15 \text{ V}, I_D = -3.5 \text{ A}$		8		S	
Diode Forward Voltage ^b	V _{SD}	$I_S = -2.5 \text{ A}, V_{GS} = 0 \text{ V}$			-1.2	V	
Dynamic ^a							
Total Gate Charge	Qg			18	30	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -30 \text{ V}, \ V_{GS} = -10 \text{ V}, \ I_D = -3.5 \text{ A}$		5			
Gate-Drain Charge	Q _{gd}			2			
Turn-On Delay Time	t _{d(on)}			8	15	ns	
Rise Time	t _r	$\begin{aligned} V_{DD} &= -30 \text{ V, } R_L = 30 \ \Omega \\ I_D &\cong -1 \text{ A, } V_{GEN} = -10 \text{ V, } R_G = 6 \ \Omega \end{aligned}$		10	20		
Turn-Off Delay Time	t _{d(off)}			35	50		
Fall Time	t _f			12	25		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -2.5 A, di/dt = 100 A/μs		70	100		

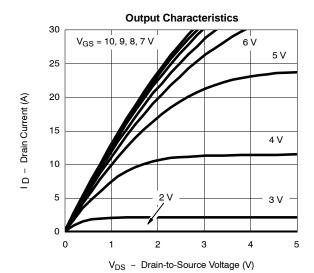
- Notes a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

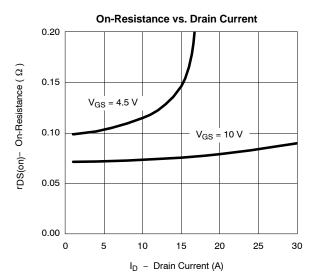
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

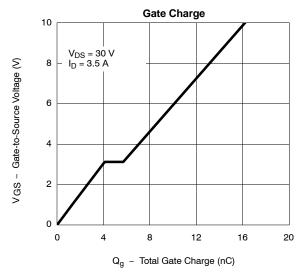


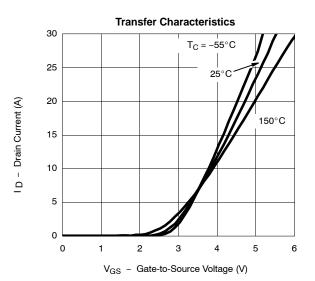
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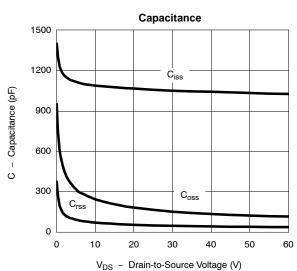
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

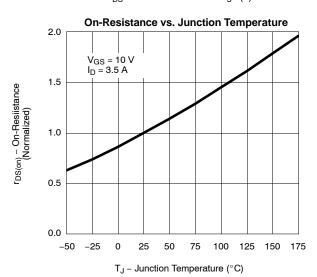








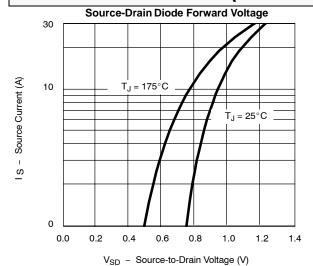


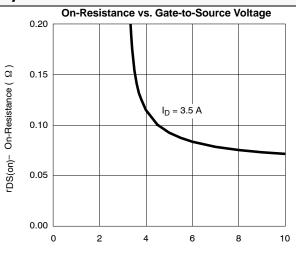


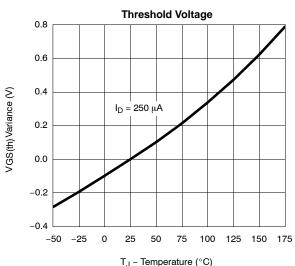
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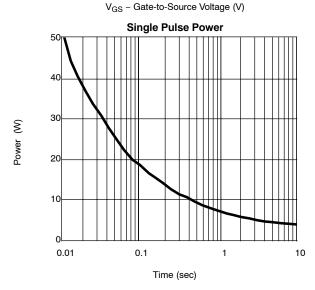


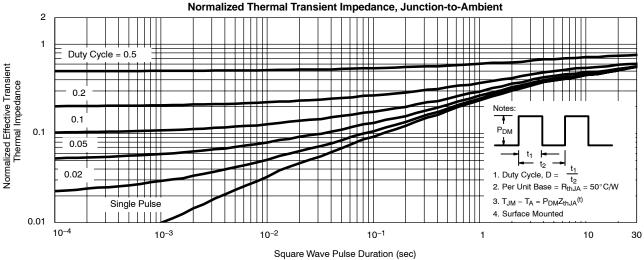
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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?70742.



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